MMIC SURFACE MOUNT

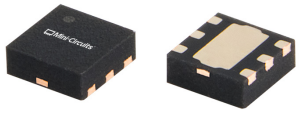
Fixed Attenuator

BAT-20+

50Ω DC to 60 GHz 1.6 W 20 dB

THE BIG DEAL

- Wideband, DC to 60 GHz
- High Power Handling, 1.6 W
- Excellent Return Loss, Typ. 18 dB
- 1.5x1.5 mm, 6-Lead QFN-Style Package

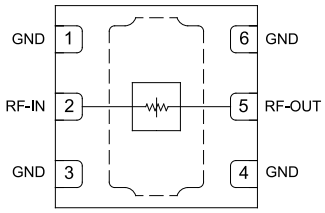


Generic photo used for illustration purposes only

APPLICATIONS

- Test & Measurement Equipment
- Satellite Communications
- Radar, EW, and ECM Defense Systems
- Telecom Infrastructure
- 5G sub-6 GHz and mmW

FUNCTIONAL DIAGRAM (TOP VIEW)



PRODUCT OVERVIEW

BAT-20+ is a wideband, bidirectional, absorptive fixed attenuator fabricated using a highly reliable and repeatable GaAs semiconductor process. Operating from DC to 60 GHz, this model achieves outstanding attenuation accuracy and flatness while maintaining excellent return loss throughout the entire band. The model can handle input power up to 1.6 W, making it an ideal choice for a wide range of applications such as Test & Measurement, Satellite Communications, Radar, EW, ECM Defense Systems, Telecom Infrastructure, and 5G.

KEY FEATURES

Features	Advantages
Wideband Operation, DC to 60 GHz	Flat attenuation response from DC to 60 GHz supports a wide array of applications including Test & Measurement Equipment, Satellite Communications, Radar, EW, ECM Defense Systems, & 5G applications.
Excellent Return Loss	Low Return Loss minimizes reflections and enables flexibility to implement anywhere within wideband signal chains.
1.5x1.5 mm 6-Lead QFN-Style Package	Small footprint saves space in dense layouts while providing low inductance and excellent thermal contact to the PCB. Industry-standard packaging allows for ease of assembly in high-volume manufacturing processes.

REV. OR
ECO-028431
BAT-20+
MCL NY
260129

Fixed Attenuator

BAT-20+

50Ω DC to 60 GHz 1.6 W 20 dB

ELECTRICAL SPECIFICATIONS[1,2] AT +25°C, 50Ω, UNLESS NOTED OTHERWISE

Parameter	Condition (GHz)	Min.	Typ.	Max.	Units
Frequency Range		DC		60	GHz
Attenuation	0.01 - 10	19.5	20.0	20.5	dB
	10 - 20	19.5	20.0	20.6	
	20 - 30	19.0	19.9	20.6	
	30 - 40	18.8	19.6	20.7	
	40 - 50		19.4		
	50 - 60		18.5		
Input Return Loss	0.01 - 10		22		dB
	10 - 20		22		
	20 - 30		25		
	30 - 40		18		
	40 - 50		18		
	50 - 60		15		
Output Return Loss	0.01 - 10		22		dB
	10 - 20		22		
	20 - 30		25		
	30 - 40		18		
	40 - 50		18		
	50 - 60		15		

1. Tested on Mini-Circuits Characterization Test/Evaluation Board TB-BAT-20C+. See Figure 2. Board loss de-embedded to the device.
2. Bi-directional RF-IN and RF-OUT ports can be interchanged.

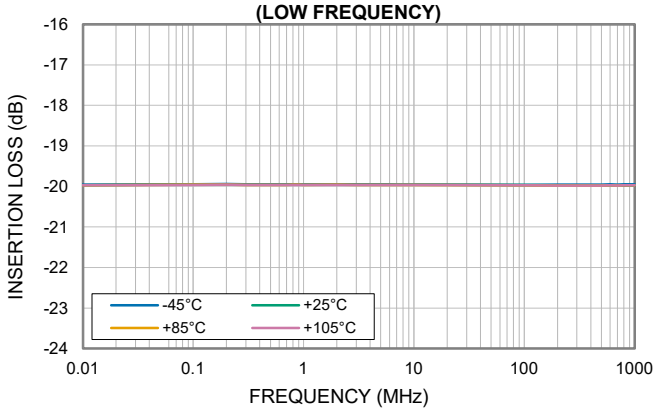
Fixed Attenuator

BAT-20+

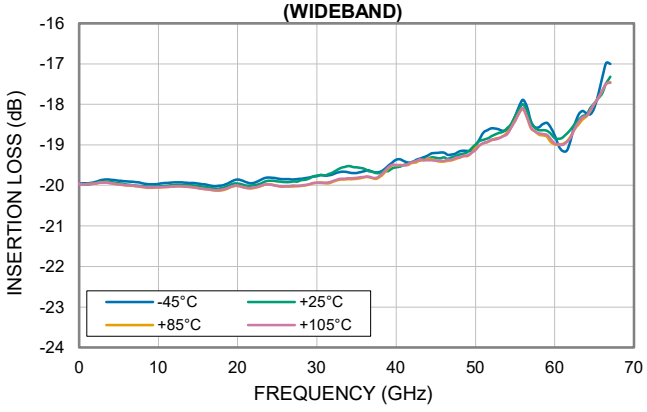
50Ω DC to 60 GHz 1.6 W 20 dB

TYPICAL PERFORMANCE GRAPHS

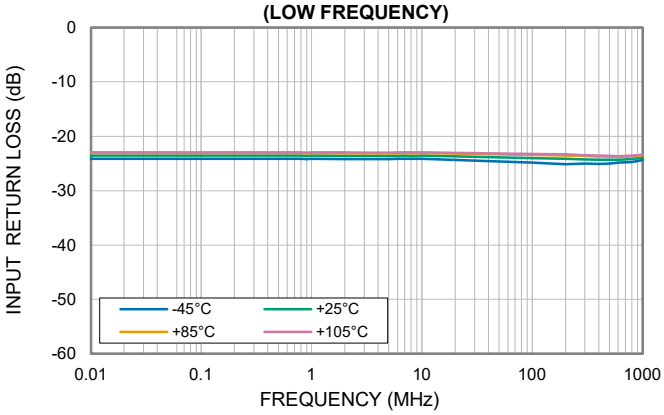
INSERTION LOSS vs. TEMPERATURE
(LOW FREQUENCY)



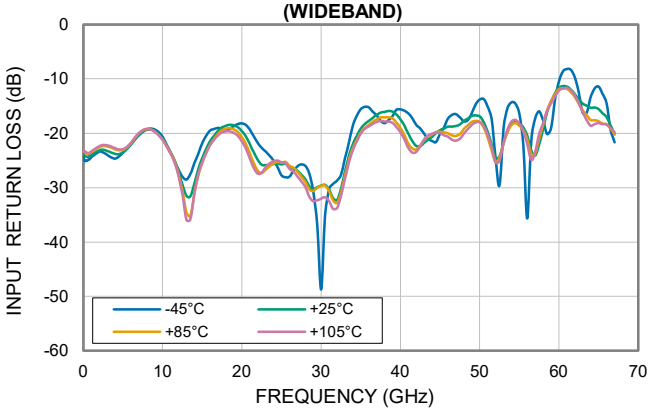
INSERTION LOSS vs. TEMPERATURE
(WIDEBAND)



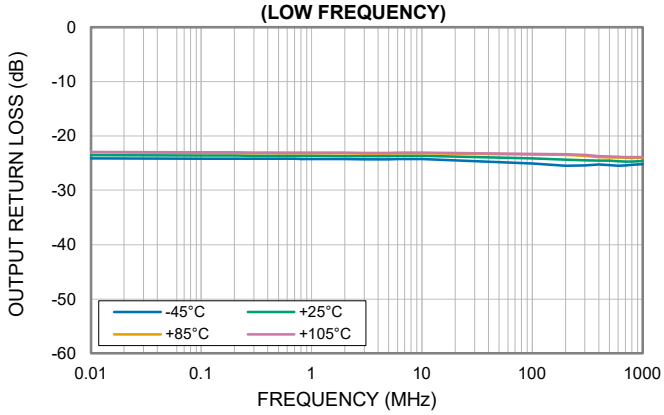
INPUT RETURN LOSS vs. TEMPERATURE
(LOW FREQUENCY)



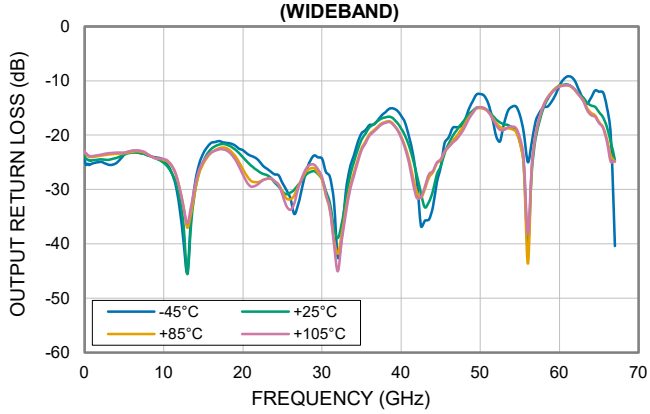
INPUT RETURN LOSS vs. TEMPERATURE
(WIDEBAND)



OUTPUT RETURN LOSS vs.TEMPERATURE
(LOW FREQUENCY)



OUTPUT RETURN LOSS vs.TEMPERATURE
(WIDEBAND)



ABSOLUTE MAXIMUM RATINGS[3]

Parameter	Ratings
Operating Temperature	-45°C to +105°C
Storage Temperature	-65°C to +150°C
RF Input Power[4]	1.6 W

3. Permanent damage may occur if any of these limits are exceeded. Maximum ratings are not intended for continuous normal operation.
4. Power derated to 1 W at +105°C.

ESD RATING

	Class	Voltage Range	Reference Standard
HBM	1C	> 1000 V	ANSI/ESDA/JEDEC JS-001-2023
CDM	C3	> 1000 V	ANSI/ESDA/JEDEC JS-002-2022

ESD HANDLING PRECAUTION: This device is designed to be Class 1C for HBM. Static charges may easily produce potentials higher than this with improper handling and can discharge into DUT and damage it. As a preventive measure Industry standard ESD handling precautions should be used at all times to protect the device from ESD damage.

MSL RATING

Moisture Sensitivity: MSL1 in accordance with IPC/JEDEC J-STD-020E /JEDEC J-STD-033C

Fixed Attenuator

BAT-20+

50Ω DC to 60 GHz 1.6 W 20 dB

FUNCTIONAL DIAGRAM (TOP VIEW)

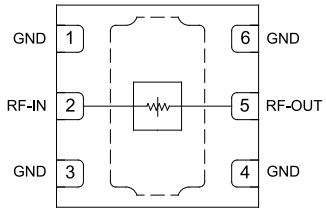


Figure 1. BAT-20+ Functional Diagram

PAD DESCRIPTION

Function	Pad #	Description (Refer to Figure 2)
RF-IN	2	RF-IN Pad connects to RF Input port.
RF-OUT	5	RF-OUT Pad connects to RF Output port.
GND	1, 3, 4, 6 & Paddle	Connects to ground.

CHARACTERIZATION TEST BOARD

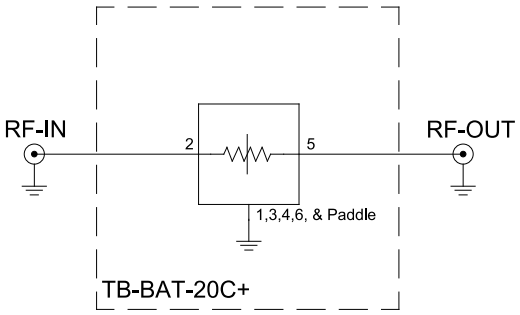


Figure 2. BAT-20+ Characterization and Application Circuit.

Electrical Parameters and Conditions
Insertion Loss and Return Loss are measured using N5247B PNA-X microwave network analyzer.

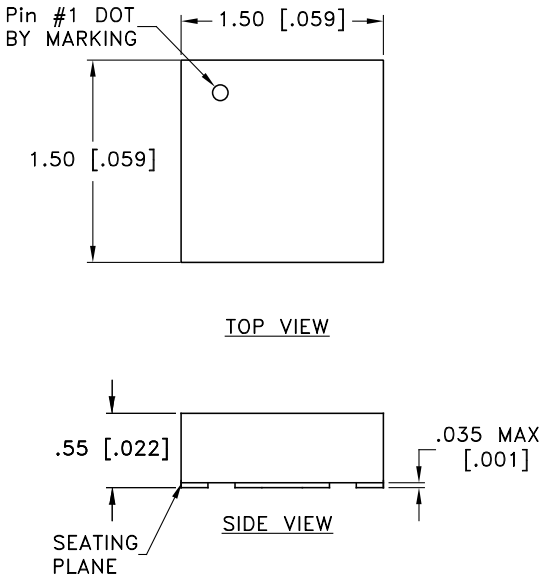
Conditions:
1. Insertion Loss and Return Loss: P_{IN} = -5 dBm

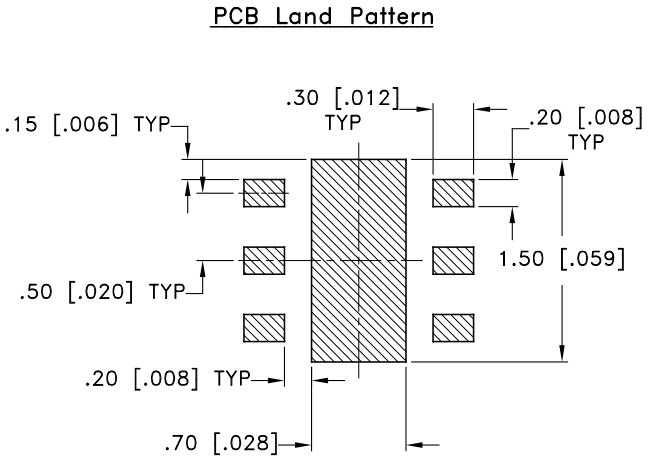
Fixed Attenuator

BAT-20+

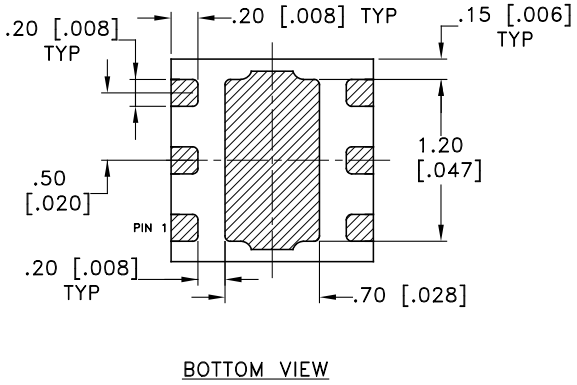
50Ω DC to 60 GHz 1.6 W 20 dB

CASE STYLE DRAWING





Suggested Layout,
Tolerance to be within ±0.050 mm

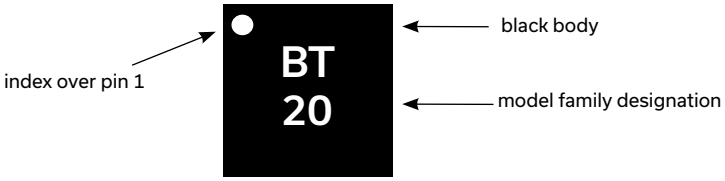


NOTES:

1. DENOTES METALLIZATION

Weight: 0.0036 grams
Dimensions are in mm [inches]. Tolerances: 2Pl. ±0.05 mm [0.002 inches].

PRODUCT MARKING



Marking may contain other features or characters for internal lot control

MMIC SURFACE MOUNT

Fixed Attenuator

BAT-20+

50Ω DC to 60 GHz 1.6 W 20 dB

ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASHBOARD CLICK HERE

Performance Data	Data Graphs S-Parameter (S2P Files) Data Set (.zip file)
Case Style	KC3011 Plastic package, exposed paddle, lead finish: Nickel-Palladium-Gold
RoHS Status	Compliant
Tape & Reel **Standard quantities available on reel**	F66 7" reels with 20, 50, 100, 200, 500, 1000, 2000, or 3000 devices
Suggested Layout for PCB Design	PL-801
Evaluation Board	TB-BAT-20C+ Gerber File
Environmental Ratings	ENV08T1

Notes

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"; Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at https://www.minicircuits.com/terms/viewterm.html

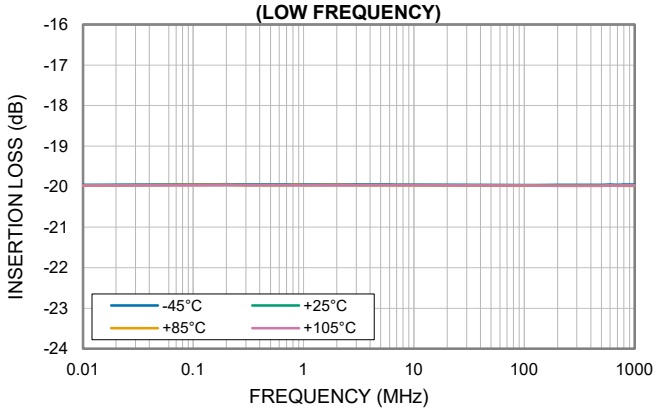
Typical Performance Data

Definitions:
Input Return Loss = -S11 (dB)
Attenuation = -S21 (dB)
Output Return Loss = -S22 (dB)

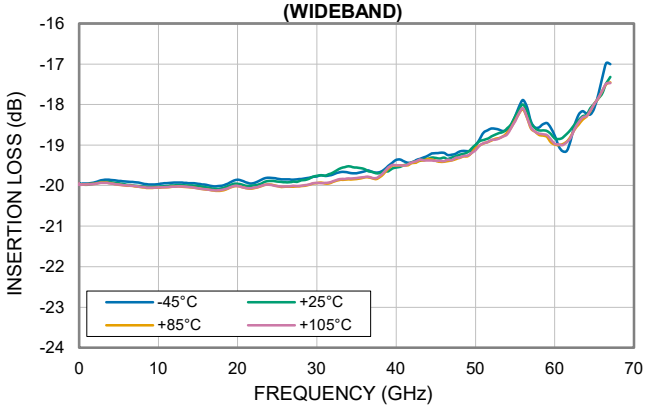
FREQ	Attenuation				Input Return Loss				Output Return Loss			
	-45°C	+25°C	+85°C	+105°C	-45°C	+25°C	+85°C	+105°C	-45°C	+25°C	+85°C	+105°C
(MHz)	(dB)	(dB)	(dB)	(dB)	(dB)	(dB)	(dB)	(dB)	(dB)	(dB)	(dB)	(dB)
0.009	19.95	19.96	19.96	19.97	24.11	23.53	23.04	22.97	24.09	23.51	23.04	22.96
0.5	19.95	19.95	19.96	19.96	24.19	23.60	23.12	23.01	24.23	23.64	23.16	23.06
1	19.95	19.95	19.96	19.96	24.16	23.58	23.10	22.99	24.24	23.65	23.17	23.07
5	19.95	19.96	19.96	19.96	24.21	23.62	23.14	23.03	24.29	23.70	23.22	23.11
10	19.95	19.96	19.96	19.96	24.18	23.61	23.12	23.01	24.27	23.68	23.20	23.08
100	19.96	19.96	19.97	19.97	24.87	24.01	23.41	23.24	25.08	24.14	23.43	23.27
200	19.96	19.97	19.97	19.97	25.14	24.16	23.51	23.33	25.52	24.34	23.51	23.33
400	19.95	19.97	19.97	19.98	25.06	24.32	23.73	23.58	25.27	24.55	23.86	23.70
600	19.95	19.97	19.97	19.97	24.86	24.32	23.81	23.69	25.50	24.69	23.99	23.85
800	19.95	19.98	19.97	19.97	24.75	24.19	23.70	23.59	25.35	24.72	24.06	23.91
1000	19.95	19.98	19.97	19.97	24.40	23.97	23.47	23.34	25.21	24.65	24.02	23.88
2000	19.92	19.95	19.95	19.96	23.40	23.12	22.53	22.37	24.91	24.48	23.81	23.62
4000	19.86	19.92	19.94	19.95	24.64	23.79	22.94	22.75	25.15	24.20	23.44	23.24
6000	19.90	19.98	20.00	19.99	21.99	22.10	21.85	21.73	22.94	23.23	23.08	22.89
8000	19.95	20.02	20.04	20.03	19.28	19.35	19.23	19.20	23.73	23.70	23.56	23.51
10000	19.96	20.02	20.05	20.05	20.69	21.06	21.21	21.28	24.60	25.13	24.56	24.42
12000	19.93	19.99	20.03	20.03	26.64	27.02	27.44	27.77	33.16	31.49	29.61	29.64
14000	19.94	20.00	20.04	20.04	25.46	29.19	31.09	30.92	28.48	29.96	29.85	28.95
16000	19.98	20.04	20.10	20.09	19.47	21.45	22.12	22.17	21.45	22.56	23.26	23.20
18000	20.00	20.06	20.12	20.11	19.30	18.62	19.16	19.67	21.43	21.78	22.47	22.89
20000	19.85	19.95	20.01	20.01	18.19	19.62	20.72	21.50	22.77	24.07	26.23	27.24
22000	19.94	20.00	20.07	20.05	21.79	24.88	26.89	27.41	24.70	26.68	28.62	28.92
24000	19.81	19.89	19.97	19.98	25.01	25.65	25.56	25.13	27.21	28.67	28.47	28.45
26000	19.85	19.92	20.03	20.02	27.98	26.22	25.98	26.53	31.66	30.60	31.83	33.78
28000	19.84	19.87	20.02	20.00	26.00	28.50	28.98	29.89	26.70	27.27	26.68	26.17
30000	19.77	19.76	19.94	19.93	48.71	29.64	29.65	32.02	24.34	28.14	28.25	27.76
32000	19.72	19.68	19.91	19.90	28.70	32.25	32.77	33.74	42.46	38.94	41.86	45.08
34000	19.68	19.52	19.84	19.82	18.59	22.03	22.80	23.15	23.83	25.04	27.00	27.62
36000	19.64	19.59	19.80	19.79	15.24	17.71	18.46	18.70	18.15	18.59	19.86	20.11
38000	19.66	19.69	19.78	19.75	18.14	16.05	17.07	17.82	15.80	16.75	17.59	17.75
40000	19.37	19.55	19.51	19.50	15.64	17.47	19.07	19.87	16.47	18.79	20.28	20.50
42000	19.43	19.42	19.44	19.42	18.45	22.35	22.98	23.46	28.51	27.41	30.48	31.56
44000	19.26	19.34	19.34	19.38	21.42	20.66	20.22	20.09	33.27	30.36	26.87	26.65
46000	19.19	19.31	19.41	19.40	17.29	18.79	20.01	20.64	20.45	21.62	22.16	22.23
48000	19.16	19.24	19.32	19.31	17.81	17.72	19.21	20.08	17.43	17.19	18.02	18.65
50000	19.01	18.99	19.07	19.12	13.80	16.92	17.92	17.95	12.43	14.94	15.03	14.88
52000	18.59	18.79	18.89	18.87	24.50	24.56	25.24	25.40	20.22	17.13	17.73	18.18
54000	18.62	18.58	18.69	18.73	14.31	18.39	18.49	17.86	14.78	18.58	18.91	18.42
56000	17.89	18.00	18.11	18.09	35.68	20.42	21.15	21.95	24.99	40.25	43.62	38.26
58000	18.56	18.64	18.75	18.72	17.73	19.15	18.35	18.05	14.87	14.99	14.53	14.51
60000	18.77	18.83	18.99	18.97	10.47	11.64	11.93	12.16	10.88	10.87	10.94	11.06
62000	18.89	18.62	18.79	18.82	9.76	12.83	13.39	13.09	10.15	11.67	11.81	11.73
64000	18.22	18.25	18.29	18.28	13.39	15.33	17.57	18.60	13.10	14.58	15.94	16.35
66000	17.33	17.72	17.65	17.66	14.48	17.05	18.36	18.40	14.91	18.52	20.73	21.21
67000	17.00	17.32	17.45	17.47	21.70	20.19	20.20	19.78	40.43	24.63	24.95	24.75

Typical Performance Curves

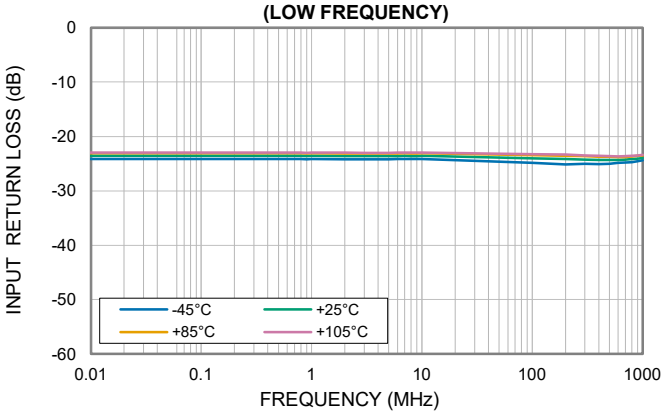
INSERTION LOSS vs. TEMPERATURE
(LOW FREQUENCY)



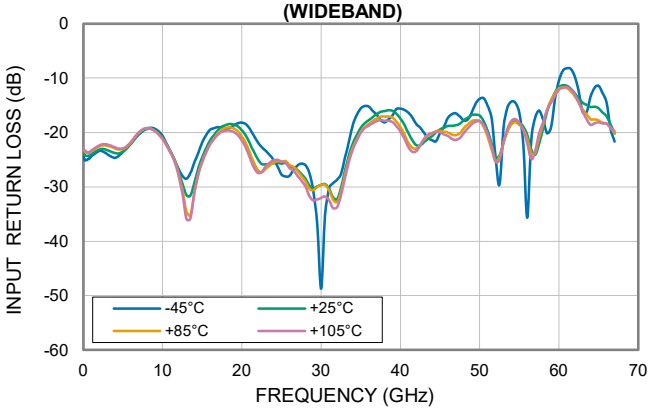
INSERTION LOSS vs. TEMPERATURE
(WIDEBAND)



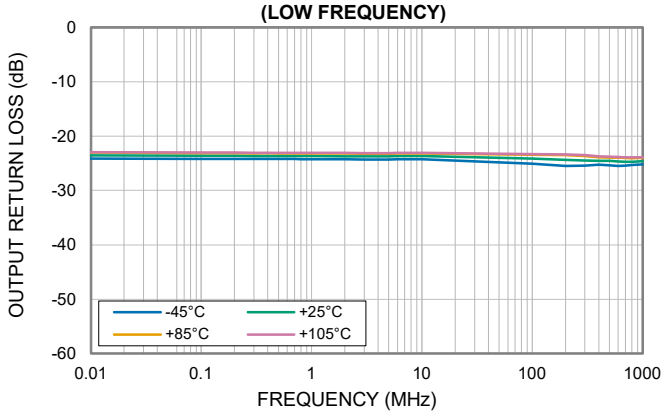
INPUT RETURN LOSS vs. TEMPERATURE
(LOW FREQUENCY)



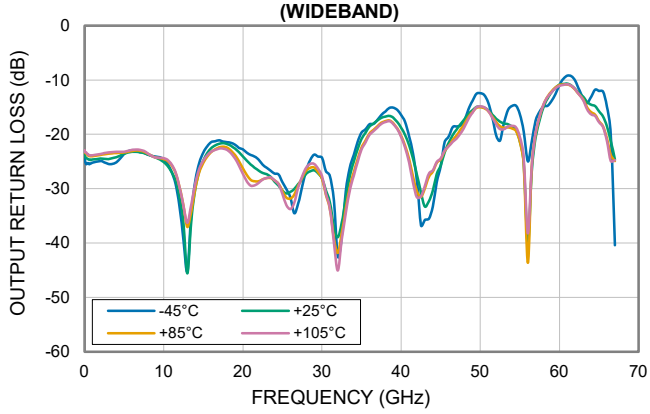
INPUT RETURN LOSS vs. TEMPERATURE
(WIDEBAND)



OUTPUT RETURN LOSS vs.TEMPERATURE
(LOW FREQUENCY)

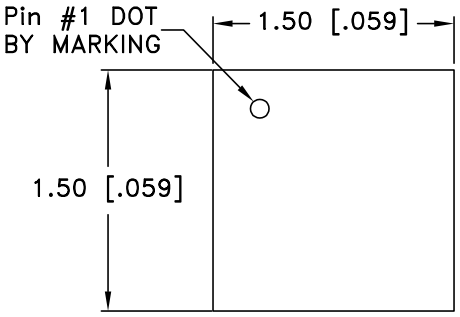


OUTPUT RETURN LOSS vs.TEMPERATURE
(WIDEBAND)

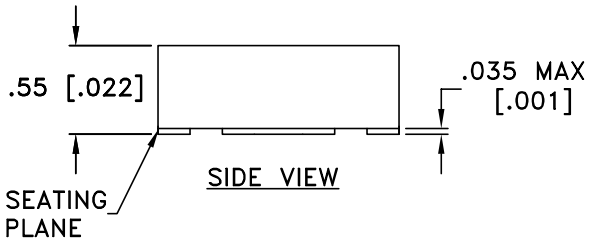


Case Style KC

Outline Dimensions KC3011

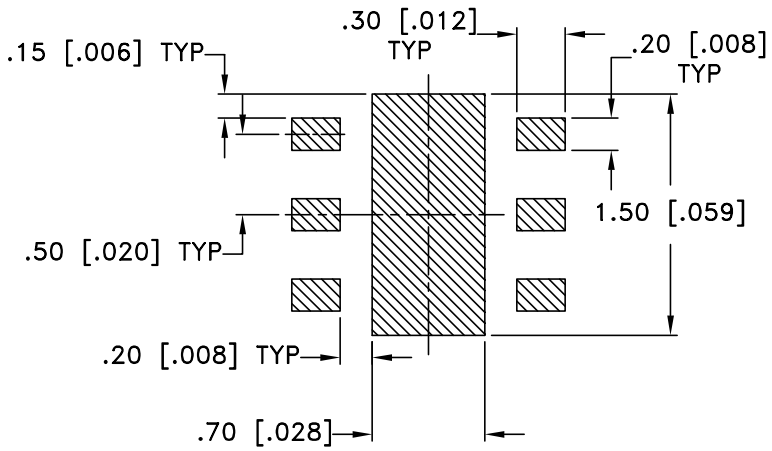


TOP VIEW

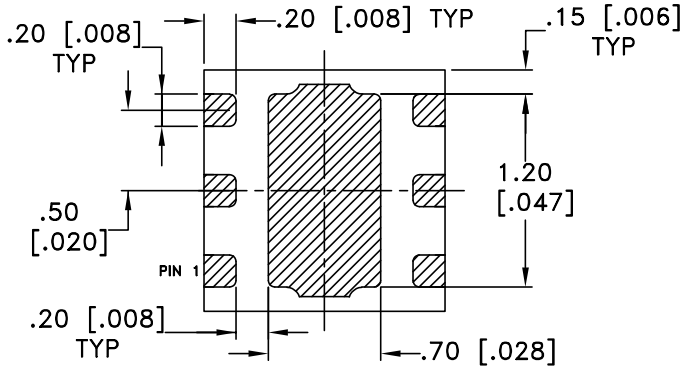


SIDE VIEW

PCB Land Pattern



Suggested Layout,
Tolerance to be within ±0.050 mm



BOTTOM VIEW

NOTES:

1. ▨ DENOTES METALLIZATION

Weight: .0036 grams

Dimensions are in mm [inches]. Tolerances: 2 Pl.± 0.05 mm

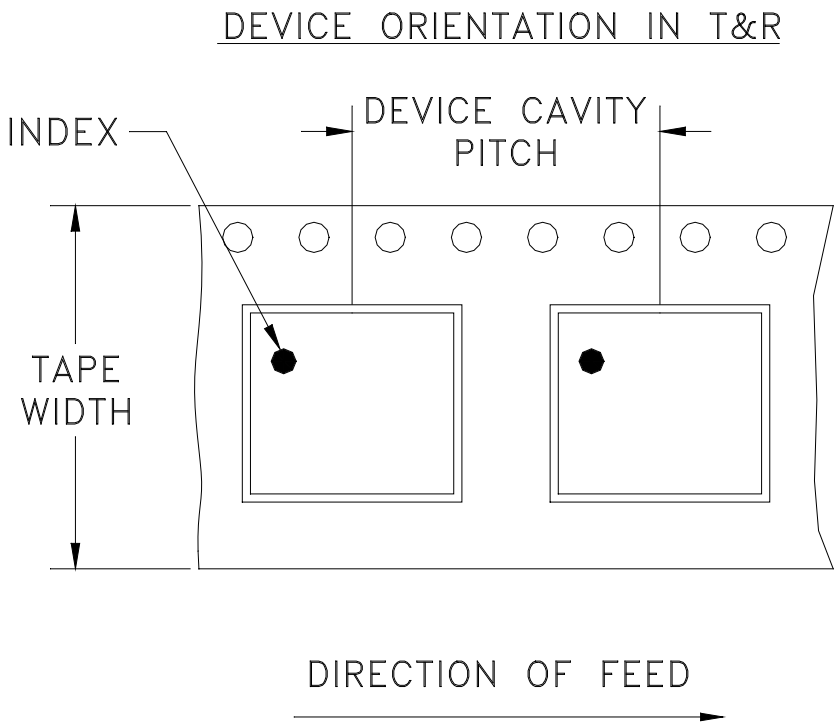
Notes:

1. Case material: Plastic.
2. Termination finish: NiPdAu (3µm/0.080µm/0.080µm) .

Mini-Circuits®
ISO 9001 ISO 14001 CERTIFIED
ALL NEW minicircuits.com
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site
The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com
RF/IF MICROWAVE COMPONENTS

This document and its contents are the property of Mini-Circuits

Tape & Reel Packaging TR-F66



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note	
8	4	7	Small quantity standard	20
				50
				100
				200
				500
		7	Standard	1000, 2000, 3000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

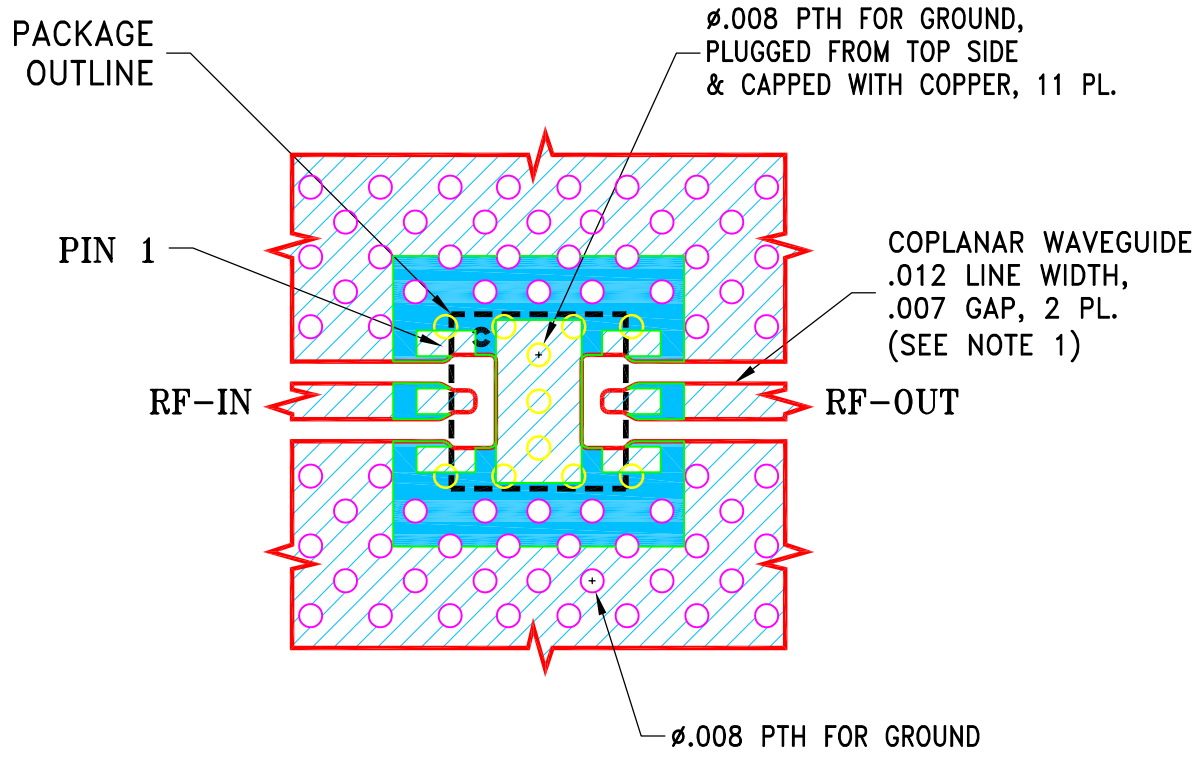
Mini-Circuits®
INTERNET http://www.minicircuits.com
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661
Distribution Centers NORTH AMERICA 800-654-7949 • 417-335-5935 • Fax 417-335-5945 • EUROPE 44-1252-832600 • Fax 44-1252-837010
Mini-Circuits ISO 9001 & ISO 14001 Certified

This document and its contents are the property of Mini-Circuits.

THIRD ANGLE PROJECTION

REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-023573	NEW RELEASE	11/08/24	ITG	IL
A	ECO-028523	ADDED CASE STYLE KC3011	02/17/26	NP	IL

SUGGESTED MOUNTING CONFIGURATION FOR KC3009 & KC3011 CASE STYLE



NOTES:

1. LINE WIDTH AND GAP ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .0066"; COPPER: 1 OZ. EACH SIDE.
   FOR OTHER MATERIALS LINE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	ITG	11/08/24
TOLERANCES ON:	CHECKED	GF	11/08/24
2 PL DECIMALS ±	APPROVED	IL	11/08/24
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

Mini-Circuits®

THIS DOCUMENT AND ITS CONTENTS ARE THE PROPERTY OF MINI-CIRCUITS. EXCEPT FOR USE EXPRESSLY GRANTED, IN WRITING, TO ITS VENDORS, VENDEE AND THE UNITED STATES GOVERNMENT, MINI-CIRCUITS RESERVES ALL PROPRIETARY DESIGN, USE , MANUFACTURING AND REPRODUCTION RIGHTS THERETO. THESE CONTENTS SHALL NOT BE USED, DUPLICATED OR DISCLOSED TO ANY OUTSIDE PARTY, IN WHOLE OR IN PART, WITHOUT WRITTEN PERMISSION OF MINI-CIRCUITS.

ASHEETA1.DWG REV:A DATE:01/12/95

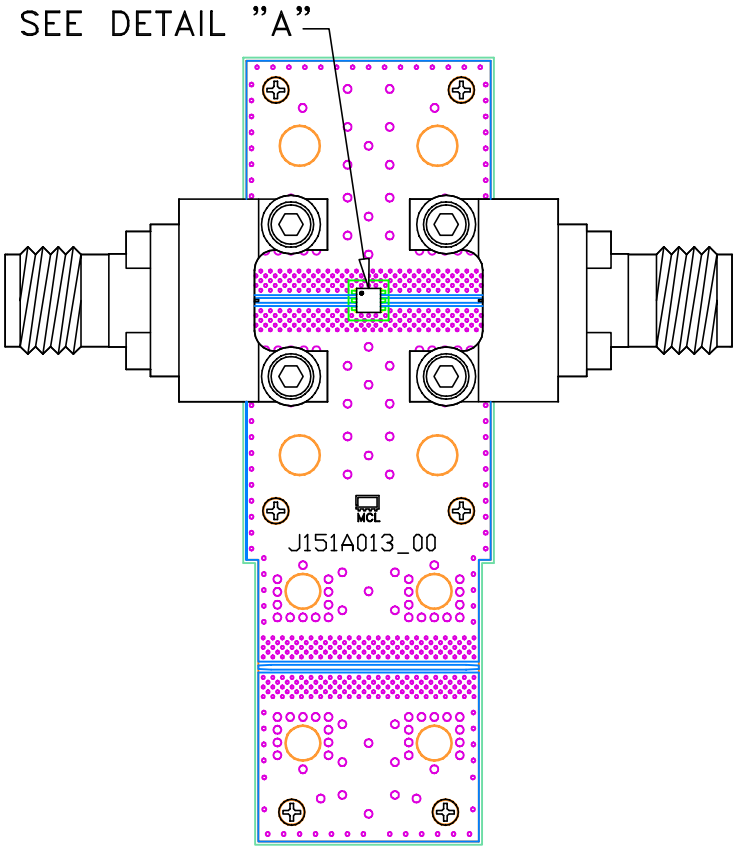
Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

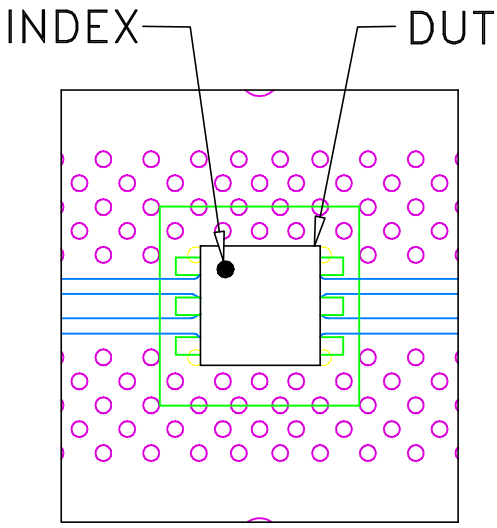
PL,KC30XX,TB-BAT-#+/TB-BAT-#C+

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-801	A

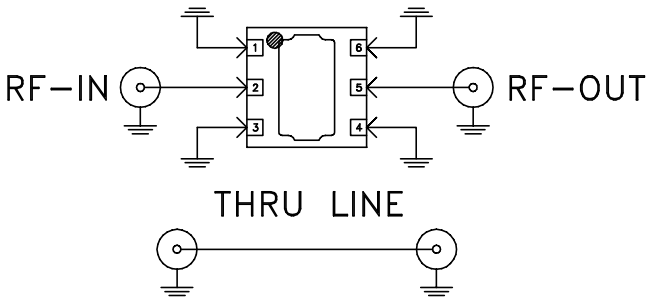
FILE:	SCALE:	SHEET:
98PL801	15:1	1 OF 1

Evaluation Board and Circuit





DETAIL "A"
(SCALE 5:1)



Schematic Diagram
(Scale 5:1)

Function	Pad
RF-IN	2
RF-OUT	5
GND	1,3,4,6

NOTES:

1. 1.85mm Female Connectors.
2. PCB Material: Roger RO4350B or equivalent, Dielectric constant=3.5, Thickness=0.0066 inch

Mini-Circuits®

THIS DOCUMENT AND ITS CONTENTS ARE THE PROPERTY OF MINI-CIRCUITS.

Mini-Circuits

Environmental Specifications ENV08T1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85° C or -45° to 85° C or -55° to 105° C or -40° to 105° C or -40° to 95° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C or -65° to 150° Ambient Environment	Individual Model Data Sheet
HTOL	1000 hours at 125°C	MIL-STD-883, Method 1005, Condition B
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Mechanical Shock	1.5Kg, 0.5 ms, 5 shock pulses, Y1 direction only	MIL-STD-883, Method 2002, Condition B, except Y1 direction only
Vibration (Variable Frequency)	50g peak	MIL-STD-883, Method 2007, Condition B
Autoclave	15 psig, 100% RH, 121°C, 96 hours	JESD22-A102, Condition C
HAST	130°C, 85% RH, 96 hours	JESD22-A110
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Solder Reflow Heat	Sn-Pb Eutetic Process: 240°C peak Pb-Free Process: 260°C peak	J-STD-020, Table 4-1, 4-2 and 5-2; Figure 5-1
Moisture Sensitivity: Level 1	Bake at 125°C for 24 hours Soak at 85°C/85% RH for 168 hours, Reflow 3 cycles at 260°C peak	J-STD-020

This document and its contents are the property of Mini-Circuits.

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

This document and its contents are the property of Mini-Circuits.